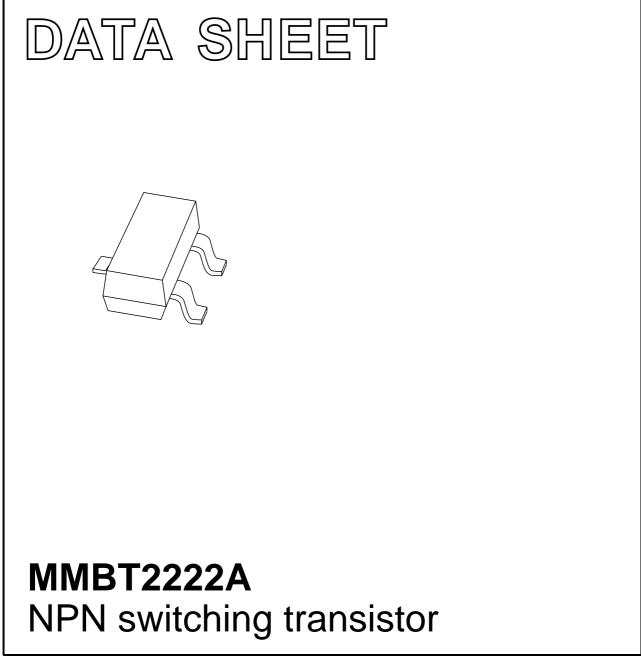
DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2000 Apr 11 2004 Jan 16



MMBT2222A

NPN switching transistor

FEATURES

- High current (max. 600 mA)
- Low voltage (max. 40 V).

APPLICATIONS

• Switching and linear amplification.

DESCRIPTION

NPN switching transistor in a SOT23 plastic package. PNP complement: PMBT2907A.

MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ | |
|-------------|-----------------------------|--|
| MMBT2222A | 7C* | |

Note

- 1. * = p: Made in Hong Kong.
 - * = t : Made in Malaysia.

* = W : Made in China.

ORDERING INFORMATION

| TYPE | | PACKAGE | | |
|-----------|------|--|--|--|
| NUMBER | NAME | NAME DESCRIPTION VE | | |
| MMBT2222A | _ | plastic surface mounted package; 3 leads | | |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|---------------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 75 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 40 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 6 | V |
| I _C | collector current (DC) | | - | 600 | mA |
| I _{CM} | peak collector current | | - | 800 | mA |
| I _{BM} | peak base current | | - | 200 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$; note 1 | - | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Note

1. Transistor mounted on an FR4 printed-circuit board.

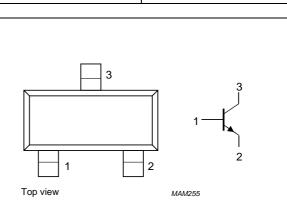


Fig.1 Simplified outline (SOT23) and symbol.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|---|------------|-------|------|
| R _{th(j-a)} | thermal resistance from junction to ambient | note 1 | 500 | K/W |

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

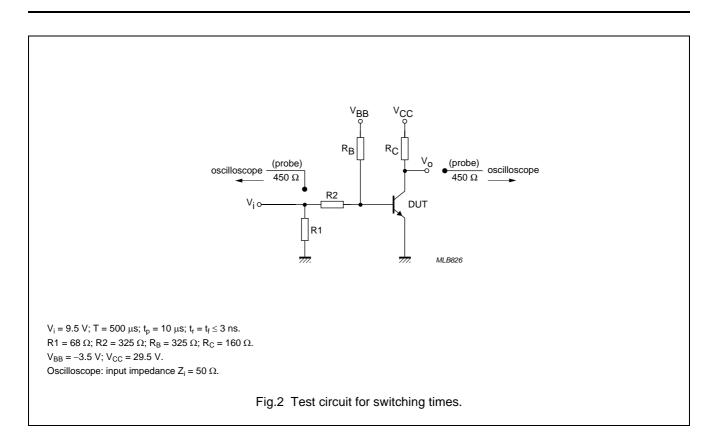
 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------------|---|---|------|------|------|
| I _{CBO} C | collector cut-off current | I _E = 0; V _{CB} = 60 V | _ | 10 | nA |
| | | I _E = 0; V _{CB} = 60 V; T _j = 125 °C | _ | 10 | μA |
| I _{EBO} | emitter cut-off current | I _C = 0; V _{EB} = 5 V | _ | 10 | nA |
| h _{FE} | DC current gain | I _C = 0.1 mA; V _{CE} = 10 V | 35 | _ | |
| | | I _C = 1 mA; V _{CE} = 10 V | 50 | _ | |
| | | I _C = 10 mA; V _{CE} = 10 V | 75 | _ | |
| | | $I_C = 10 \text{ mA}; V_{CE} = 10 \text{ V};$ $T_{amb} = -55 ^{\circ}\text{C}$ | 35 | - | |
| | | I _C = 150 mA; V _{CE} = 10 V | 100 | 300 | |
| | | I _C = 150 mA; V _{CE} = 1 V | 50 | _ | |
| | | I _C = 500 mA; V _{CE} = 10 V | 40 | - | |
| V _{CEsat} | collector-emitter saturation voltage | I _C = 150 mA; I _B = 15 mA; note 1 | _ | 300 | mV |
| | | $I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}; \text{ note } 1$ | _ | 1 | V |
| V _{BEsat} | base-emitter saturation voltage | I _C = 150 mA; I _B = 15 mA; note 1 | 0.6 | 1.2 | V |
| | | $I_{C} = 500 \text{ mA}; I_{B} = 50 \text{ mA}; \text{ note } 1$ | _ | 2 | V |
| C _c | collector capacitance | $I_E = i_e = 0; V_{CB} = 10 V;$ f = 1 MHz | - | 8 | pF |
| C _e | emitter capacitance | $I_{C} = i_{c} = 0; V_{EB} = 500 \text{ mV};$ f = 1 MHz | - | 25 | pF |
| f _T | transition frequency | $I_{C} = 20 \text{ mA}; V_{CE} = 20 \text{ V};$ f = 100 MHz | 300 | - | MHz |
| F | noise figure $I_{C} = 100 \ \mu\text{A}; \ V_{CE} = 5 \ \text{V}; \\ R_{S} = 1 \ \text{k}\Omega; \ \text{f} = 1 \ \text{kHz}$ | | - | 4 | dB |
| Switching t | imes (between 10% and 90% levels); (se | ee Fig.2) | | | |
| t _{on} | turn-on time | I _{Con} = 150 mA; I _{Bon} = 15 mA; | - | 35 | ns |
| t _d | delay time | $I_{Boff} = -15 \text{ mA}$ | _ | 15 | ns |
| t _r | rise time | | _ | 20 | ns |
| t _{off} | turn-off time | | - | 250 | ns |
| ts | storage time | | _ | 200 | ns |
| t _f | fall time | | - | 60 | ns |

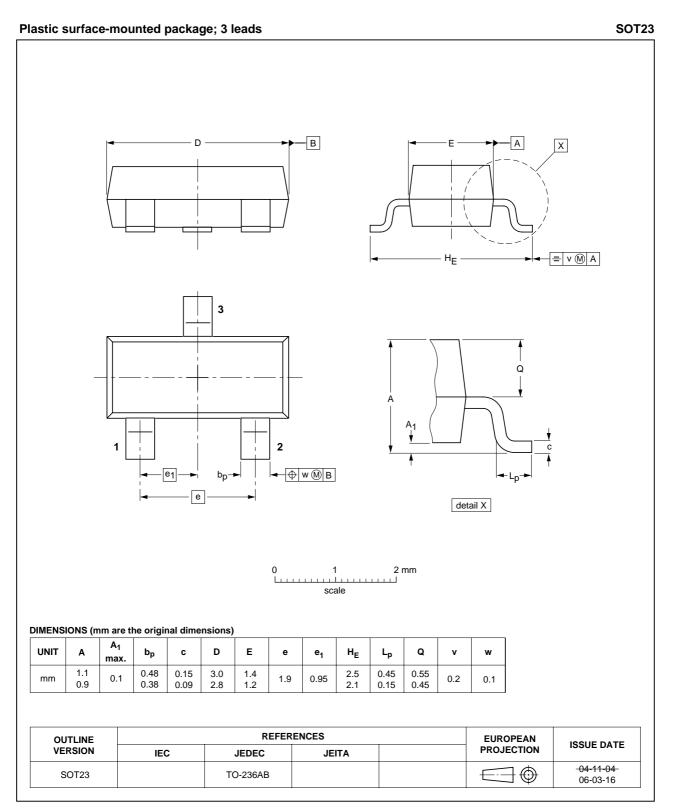
Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

MMBT2222A



PACKAGE OUTLINE



MMBT2222A

MMBT2222A

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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Printed in The Netherlands

R75/02/pp7

Date of release: 2004 Jan 16

Document order number: 9397 750 12432



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Contact Us :

> Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales :

- Direct +86 (21) 6401-6692
- Email amall@ameya360.com
- QQ 800077892
- Skype ameyasales1 ameyasales2

> Customer Service :

Email service@ameya360.com

> Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com